SHIGA7.037APC PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : TAMURA, K. et al.

Appl. No. : 10/560,126

Filed August 28, 2006

For : POSITIVE RESIST

COMPOSITION, RESIST

LAMINATES AND PROCESS FOR FORMING RESIST

PATTERNS

: C. Hamilton Examiner

Group Art Unit : 1752

## SECOND PRELIMINARY AMENDMENT

## Mail Stop Amendment

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

## Dear Sir:

Preliminary to examination on the merits, please amend the above-referenced application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.